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(54) Title: PHENOL RESIN, USE OF A PHENOL RESIN AS WELL AS MOULDED PRODUCT FORMED THEREFROM

(57) Abstract: The present invention relates to a phenol resin obtained by reacting phenolic compounds with formaldehyde and/or formaldehyde-forming compounds. The present invention furthermore relates to the use of such a phenol resin, as well as to a moulded product having a core of solid, inert parts impregnated with such a phenol resin.

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